'290, 'LS290 . . . DECADE COUNTERS
'293, 'LS293 . . . 4-BIT BINARY COUNTERS

- GND and V_{CC} on Corner Pins (Pins 7 and 14 Respectively)

description

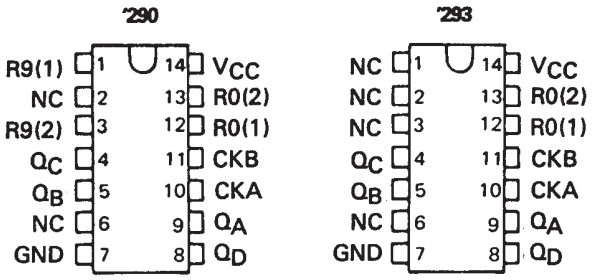
The SN54290/SN74290, SN54LS290/SN74LS290, SN54293/SN74293, and SN54LS293/SN74LS293 counters are electrically and functionally identical to the SN5490A/SN7490A, SN54LS90/SN74LS90, SN5493A/SN7493A, and SN54LS93/SN74LS93, respectively. Only the arrangement of the terminals has been changed for the '290, 'LS290, '293, and 'LS293.

Each of these monolithic counters contains four master-slave flip-flops and additional gating to provide a divide-by-two counter and a three-stage binary counter for which the count cycle length is divide-by-five for the '290 and 'LS290 and divide-by-eight for the '293 and 'LS293.

All of these counters have a gated zero reset and the '290 and 'LS290 also have gated set-to-nine inputs for use in BCD nine's complement applications.

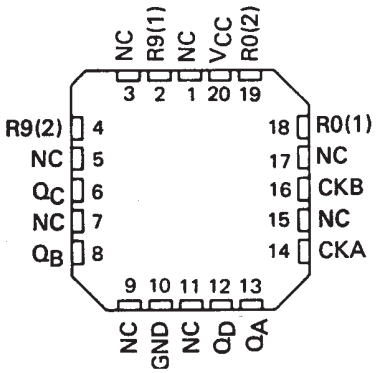
To use the maximum count length (decade or four-bit binary) of these counters, the B input is connected to the Q_A output. The input count pulses are applied to input A and the outputs are as described in the appropriate function table. A symmetrical divide-by-ten count can be obtained from the '290 and 'LS290 counters by connecting the Q_D output to the A input and applying the input count to the B input which gives a divide-by-ten square wave at output Q_A.

SN54290, SN54LS290, SN54293, SN54LS293 . . . J OR W PACKAGE
SN74290, SN74293 . . . N PACKAGE
SN74LS290, SN74LS293 . . . D OR N PACKAGE
(TOP VIEW)

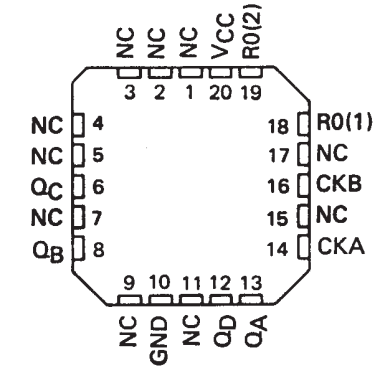


SN54LS290, SN54LS293 . . . FK PACKAGE
(TOP VIEW)

'LS290



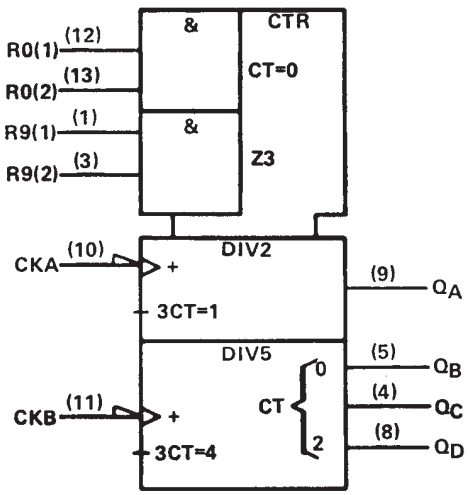
'LS293



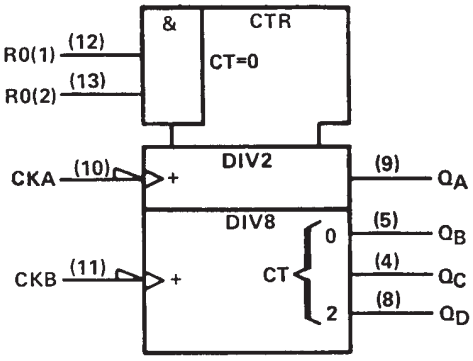
NC – No internal connection

logic symbols†

'290, 'LS290



'293, 'LS293



† These symbols are in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.
Pin numbers shown are for D, J, N, and W packages.

'290, 'LS290
BCD COUNT SEQUENCE
(See Note A)

COUNT	OUTPUT			
	Q_D	Q_C	Q_B	Q_A
0	L	L	L	L
1	L	L	L	H
2	L	L	H	L
3	L	L	H	H
4	L	H	L	L
5	L	H	L	H
6	L	H	H	L
7	L	H	H	H
8	H	L	L	L
9	H	L	L	H

'290, 'LS290
BI-QUINARY (5-2)
(See Note B)

COUNT	OUTPUT			
	Q_A	Q_D	Q_C	Q_B
0	L	L	L	L
1	L	L	L	H
2	L	L	H	L
3	L	L	H	H
4	L	H	L	L
5	H	L	L	L
6	H	L	L	H
7	H	L	H	L
8	H	L	H	H
9	H	H	L	L

'290, 'LS290
RESET/COUNT FUNCTION TABLE

RESET INPUTS				OUTPUT			
$R_{0(1)}$	$R_{0(2)}$	$R_{9(1)}$	$R_{9(2)}$	Q_D	Q_C	Q_B	Q_A
H	H	L	X	L	L	L	L
H	H	X	L	L	L	L	L
X	X	H	H	H	L	L	H
X	L	X	L	COUNT			
L	X	L	X	COUNT			
L	X	X	L	COUNT			
X	L	L	X	COUNT			

'293, 'LS293
RESET/COUNT FUNCTION TABLE

RESET INPUTS		OUTPUT			
$R_{0(1)}$	$R_{0(2)}$	Q_D	Q_C	Q_B	Q_A
H	H	L	L	L	L
L	X	COUNT			
X	L	COUNT			

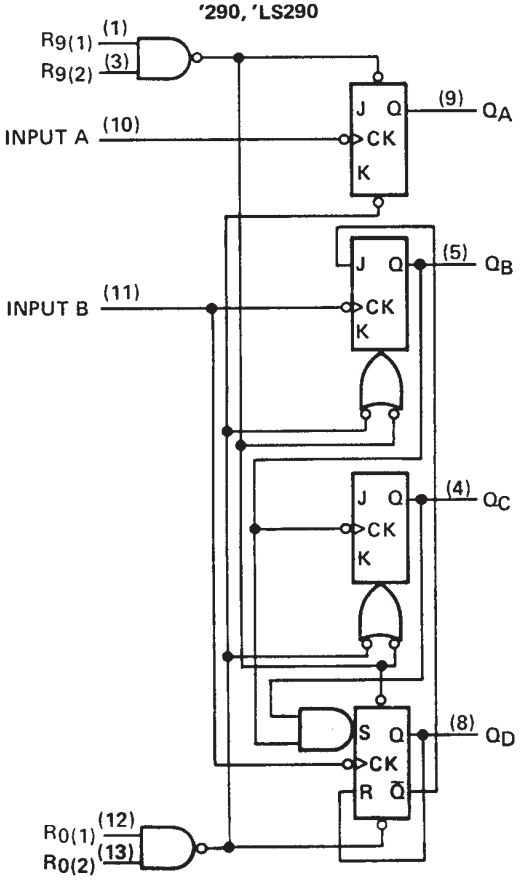
'293, 'LS293
COUNT SEQUENCE
(See Note C)

COUNT	OUTPUT			
	Q_D	Q_C	Q_B	Q_A
0	L	L	L	L
1	L	L	L	H
2	L	L	H	L
3	L	L	H	H
4	L	H	L	L
5	L	H	L	H
6	L	H	H	L
7	L	H	H	H
8	H	L	L	L
9	H	L	L	H
10	H	L	H	L
11	H	L	H	H
12	H	H	L	L
13	H	H	L	H
14	H	H	H	L
15	H	H	H	H

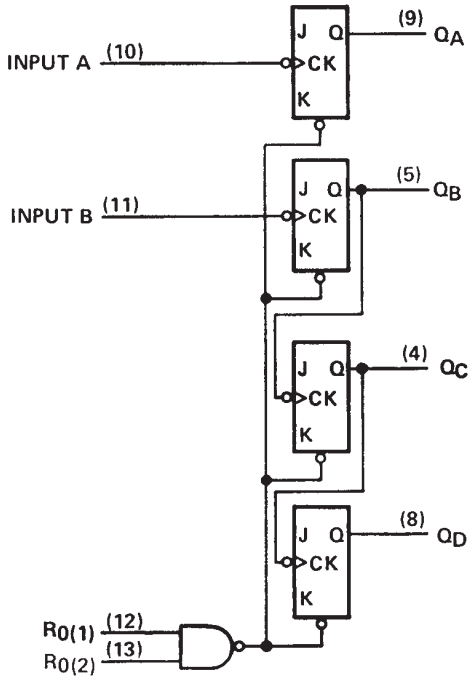
NOTES: A. Output Q_A is connected to input B for BCD count.
B. Output Q_D is connected to input A for bi-quinary count.
C. Output Q_A is connected to input B.
D. H = high level, L = low level, X = irrelevant

logic diagrams (positive logic)

'290, 'LS290

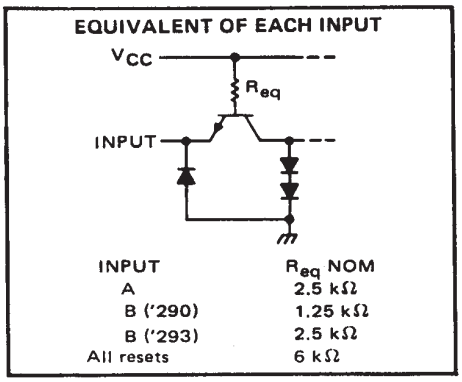


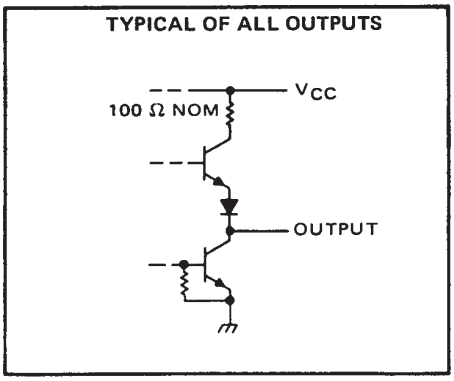
'293, 'LS293



Pin numbers shown are for D, J, N, and W packages.
The J and K inputs shown without connection are for reference only and are functionally at a high level.

schematics of inputs and outputs





absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, V_{CC} (see Note 1) . . . . . 7 V
Input voltage . . . . . 5.5 V
Interemitter voltage (see Note 2) . . . . . 5.5 V
Operating free-air temperature range: SN54' Circuits . . . . . −55°C to 125°C
SN74' Circuits . . . . . 0°C to 70°C
Storage temperature range . . . . . −65°C to 150°C

NOTES: 1. Voltage values, except interemitter voltage, are with respect to network ground terminal.
2. This is the voltage between two emitters of a multiple-emitter transistor. For these circuits, this rating applies between the two R_0 inputs, and for the '290 circuit, it also applies between the two R9 inputs.

recommended operating conditions

		SN54'			SN74'			UNIT
		MIN	NOM	MAX	MIN	NOM	MAX	
Supply voltage, V_{CC}		4.5	5	5.5	4.75	5	5.25	V
High-level output current, I_{OH}				−800			−800	μA
Low-level output current, I_{OL}				16			16	mA
Count frequency, f_{count}	A input	0		32	0		32	MHz
	B input	0		16	0		16	
Pulse width, t_w	A input	15			15			ns
	B input	30			30			
	Reset inputs	15			15			
Reset inactive-state setup time, t_{su}		25			25			ns
Operating free-air temperature, T_A		−55		125	0		70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER			TEST CONDITIONS†		'290 MIN	'290 TYP‡	'290 MAX	'293 MIN	'293 TYP‡	'293 MAX	UNIT
V_{IH}	High-level input voltage				2			2			V
V_{IL}	Low-level input voltage						0.8			0.8	V
V_{IK}	Input clamp voltage		V_{CC} = MIN, I_I = −12 mA				−1.5			−1.5	V
V_{OH}	High-level output voltage		V_{CC} = MIN, V_{IH} = 2 V, V_{IL} = 0.8 V, I_{OH} = −800 μA		2.4	3.4		2.4	3.4		V
V_{OL}	Low-level output voltage		V_{CC} = MIN, V_{IH} = 2 V, V_{IL} = 0.8 V, I_{OL} = 16 mA¶			0.2	0.4		0.2	0.4	V
I_I	Input current at maximum input voltage		V_{CC} = MAX, V_I = 5.5 V				1			1	mA
I_{IH}	High-level input current	Any reset	V_{CC} = MAX, V_I = 2.4 V				40			40	μA
		A input					80			80	
		B input					120			80	
I_{IL}	Low-level input current	Any reset	V_{CC} = MAX, V_I = 0.4 V				−1.6			−1.6	mA
		A input					−3.2			−3.2	
		B input					−4.8			−3.2	
I_{OS}	Short-circuit output current§		V_{CC} = MAX	SN54'	−20		−57	−20		−57	mA
				SN74'	−18		−57	−18		−57	
I_{CC}	Supply current		V_{CC} = MAX, See Note 3			29	42		26	39	mA

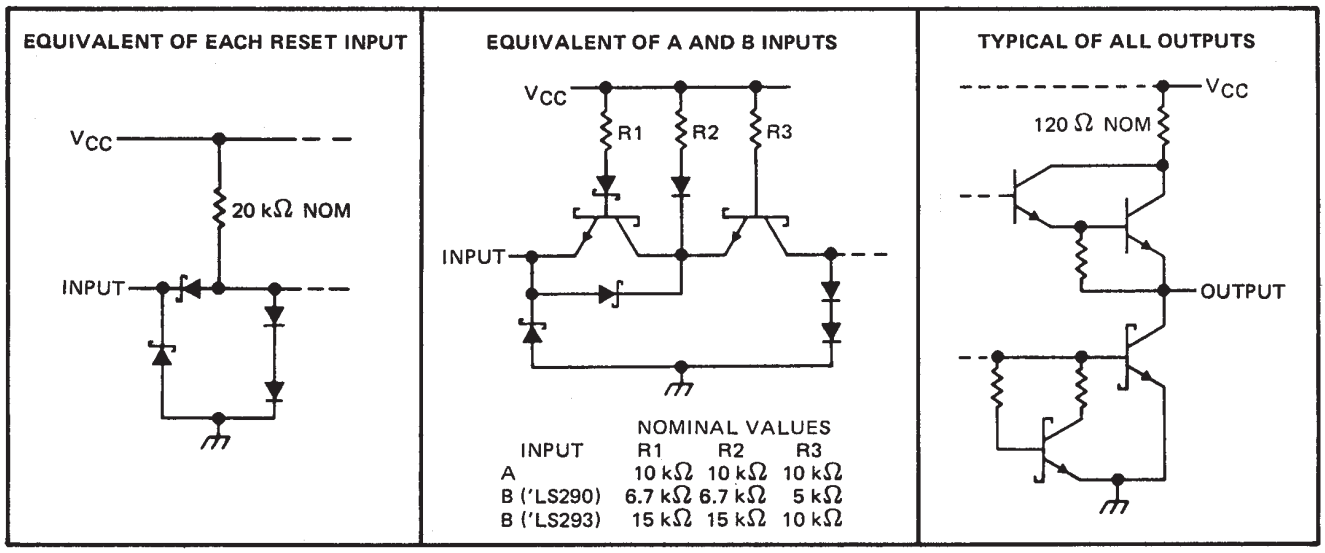
†For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.
‡All typical values are at V_{CC} = 5 V, T_A = 25°C.
§Not more than one output should be shorted at a time.
¶Q_A outputs are tested at I_{OL} = 16 mA plus the limit value of I_{IL} for the B input. This permits driving the B input while maintaining full fan-out capability.
NOTE 3: I_{CC} is measured with all outputs open, both R_0 inputs grounded following momentary connection to 4.5 V, and all other inputs grounded.

switching characteristics, V_{CC} = 5 V, T_A = 25°C

PARAMETER#	FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS	'290 MIN	'290 TYP	'290 MAX	'293 MIN	'293 TYP	'293 MAX	UNIT
f_{max}	A	Q_A	C_L = 15 pF, R_L = 400 Ω, See Note 4	32	42		32	42		MHz
	B	Q_B		16			16			
t_{PLH}	A	Q_A			10	16		10	16	ns
t_{PHL}					12	18		12	18	
t_{PLH}	A	Q_D			32	48		46	70	ns
t_{PHL}					34	50		46	70	
t_{PLH}	B	Q_B			10	16		10	16	ns
t_{PHL}					14	21		14	21	
t_{PLH}	B	Q_C			21	32		21	32	ns
t_{PHL}					23	35		23	35	
t_{PLH}	B	Q_D			21	32		34	51	ns
t_{PHL}					23	35		34	51	
t_{PHL}	Set-to-0	Any			26	40		26	40	ns
t_{PLH}	Set-to-9	Q_A, Q_D			20	30				ns
t_{PHL}		Q_B, Q_C			26	40				

#f_{max} = maximum count frequency
t_{PLH} = propagation delay time, low-to-high-level output
t_{PHL} = propagation delay time, high-to-low-level output
NOTE 4: Load circuits and voltage waveforms are shown in Section 1.

schematics of inputs and outputs



absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, V_{CC} (see Note 5) . . . . . 7 V
Input voltage: R inputs . . . . . 7 V
A and B inputs . . . . . 5.5 V
Operating free-air temperature range: SN54LS290, SN54LS293 . . . . . −55°C to 125°C
SN74LS290, SN74LS293 . . . . . 0°C to 70°C
Storage temperature range . . . . . −65°C to 150°C

NOTE 5: Voltage values are with respect to network ground terminal.

recommended operating conditions

		SN54LS'			SN74LS'			UNIT
		MIN	NOM	MAX	MIN	NOM	MAX	
Supply voltage, V_{CC}		4.5	5	5.5	4.75	5	5.25	V
High-level output current, I_{OH}				−400			−400	μA
Low-level output current, I_{OL}				4			8	mA
Count frequency, f_{count}	A input	0		32	0		32	MHz
	B input	0		16	0		16	
Pulse width, t_w	A input	15			15			ns
	B input	30			30			
	Reset inputs	30			30			
Reset inactive-state setup time, t_{su}		25			25			ns
Operating free-air temperature, T_A		−55		125	0		70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER			TEST CONDITIONS†			SN54LS' MIN	SN54LS' TYP‡	SN54LS' MAX	SN74LS' MIN	SN74LS' TYP‡	SN74LS' MAX	UNIT
V_{IH}	High-level input voltage					2			2			V
V_{IL}	Low-level input voltage							0.7			0.8	V
V_{IK}	Input clamp voltage		V_{CC} = MIN,	I_I = −18 mA				−1.5			−1.5	V
V_{OH}	High-level output voltage		V_{CC} = MIN, V_{IL} = V_{IL} max,	V_{IH} = 2 V, I_{OH} = −400 μA		2.5	3.4		2.7	3.4		V
V_{OL}	Low-level output voltage		V_{CC} = MIN, V_{IL} = V_{IL} max	V_{IH} = 2 V,	I_{OL} = 4 mA¶		0.25	0.4		0.25	0.4	V
					I_{OL} = 8 mA¶					0.35	0.5	
I_I	Input current at maximum input voltage	Any reset	V_{CC} = MAX,	V_I = 7 V				0.1			0.1	mA
		A input	V_{CC} = MAX,	V_I = 5.5 V				0.2			0.2	
		B of 'LS290						0.4			0.4	
		B of 'LS293						0.2			0.2	
I_{IH}	High-level input current	Any reset	V_{CC} = MAX,	V_I = 2.7 V				20			20	μA
		A input						40			40	
		B of 'LS290						80			80	
		B of 'LS293						40			40	
I_{IL}	Low-level input current	Any reset	V_{CC} = MAX,	V_I = 0.4 V				−0.4			−0.4	mA
		A input						−2.4			−2.4	
		B of 'LS290						−3.2			−3.2	
		B of 'LS293						−1.6			−1.6	
I_{OS}	Short-circuit output current§		V_{CC} = MAX			−20		−100	−20		−100	mA
I_{CC}	Supply current		V_{CC} = MAX,	See Note 3	'LS290		9	15		9	15	mA
					'LS293		9	15		9	15	

†For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.
‡All typical values are at V_{CC} = 5 V, T_A = 25°C.
§Not more than one output should be shorted at a time, and duration of the short-circuit should not exceed one second.
¶Q_A outputs are tested at specified I_{OL} plus the limit value of I_{IL} for the B input. This permits driving the B input while maintaining full fan-out capability.
NOTE 3: I_{CC} is measured with all outputs open, both R_0 inputs grounded following momentary connection to 4.5 V, and all other inputs grounded.

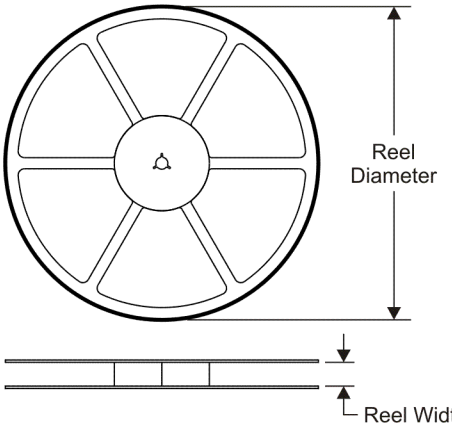
switching characteristics, V_{CC} = 5 V, T_A = 25°C

PARAMETER#	FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS	'LS290 MIN	'LS290 TYP	'LS290 MAX	'LS293 MIN	'LS293 TYP	'LS293 MAX	UNIT
f_{max}	A	Q_A	C_L = 15 pF, R_L = 2 kΩ, See Note 4	32	42		32	42		MHz
	B	Q_B		16			16			
t_{PLH}	A	Q_A			10	16		10	16	ns
t_{PHL}					12	18		12	18	
t_{PLH}	A	Q_D			32	48		46	70	ns
t_{PHL}					34	50		46	70	
t_{PLH}	B	Q_B			10	16		10	16	ns
t_{PHL}					14	21		14	21	
t_{PLH}	B	Q_C			21	32		21	32	ns
t_{PHL}					23	35		23	35	
t_{PLH}	B	Q_D			21	32		34	51	ns
t_{PHL}					23	35		34	51	
t_{PHL}	Set-to-0	Any			26	40		26	40	ns
t_{PLH}	Set-to-9	Q_A, Q_D			20	30				ns
t_{PHL}		Q_B, Q_C			26	40				

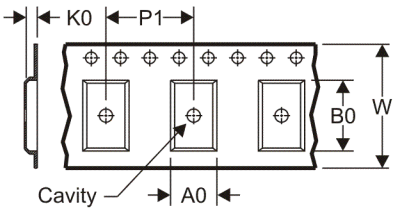
#f_{max} = maximum count frequency
t_{PLH} = propagation delay time, low-to-high-level output
t_{PHL} = propagation delay time, high-to-low-level output
NOTE 4: Load circuits and voltage waveforms are shown in Section 1.

TAPE AND REEL INFORMATION

REEL DIMENSIONS

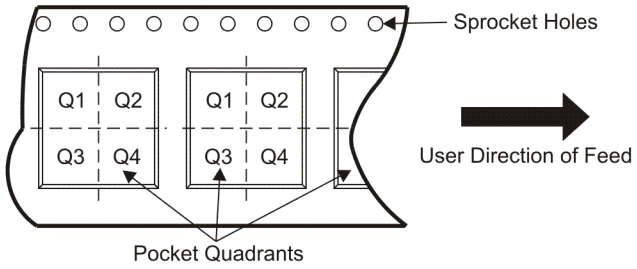


TAPE DIMENSIONS



A0	Dimension designed to accommodate the component width
B0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

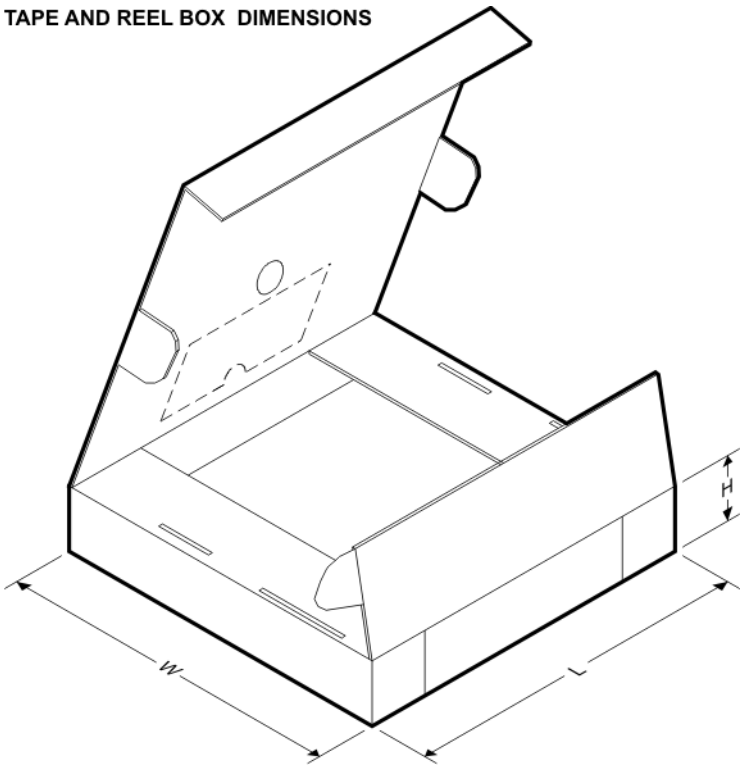
QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
SN74LS293DR	SOIC	D	14	2500	330.0	16.4	6.5	9.0	2.1	8.0	16.0	Q1

TAPE AND REEL BOX DIMENSIONS



*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
SN74LS293DR	SOIC	D	14	2500	346.0	346.0	33.0

PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead finish/ Ball material (6)	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
SN74LS293D	ACTIVE	SOIC	D	14	50	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	LS293	Samples
SN74LS293N	ACTIVE	PDIP	N	14	25	RoHS & Green	NIPDAU	N / A for Pkg Type	0 to 70	SN74LS293N	Samples

(1) The marketing status values are defined as follows:
ACTIVE: Product device recommended for new designs.
LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.
NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.
PREVIEW: Device has been announced but is not in production. Samples may or may not be available.
OBSOLETE: TI has discontinued the production of the device.

(2) **RoHS:** TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".
RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.
Green: TI defines "Green" to mean the content of Chlorine (Cl) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

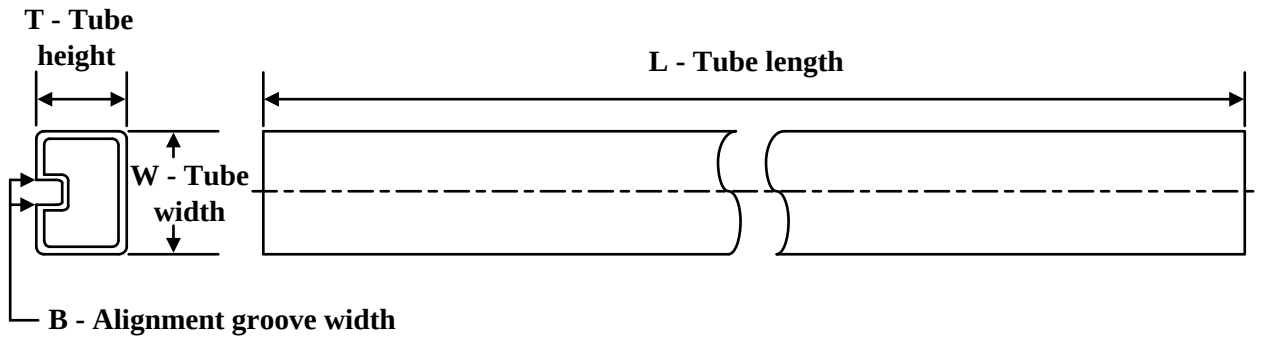
(3) MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

(4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

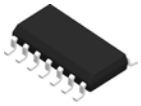
(6) Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

TUBE



*All dimensions are nominal

Device	Package Name	Package Type	Pins	SPQ	L (mm)	W (mm)	T (µm)	B (mm)
SN74LS293D	D	SOIC	14	50	506.6	8	3940	4.32
SN74LS293N	N	PDIP	14	25	506	13.97	11230	4.32
SN74LS293N	N	PDIP	14	25	506	13.97	11230	4.32

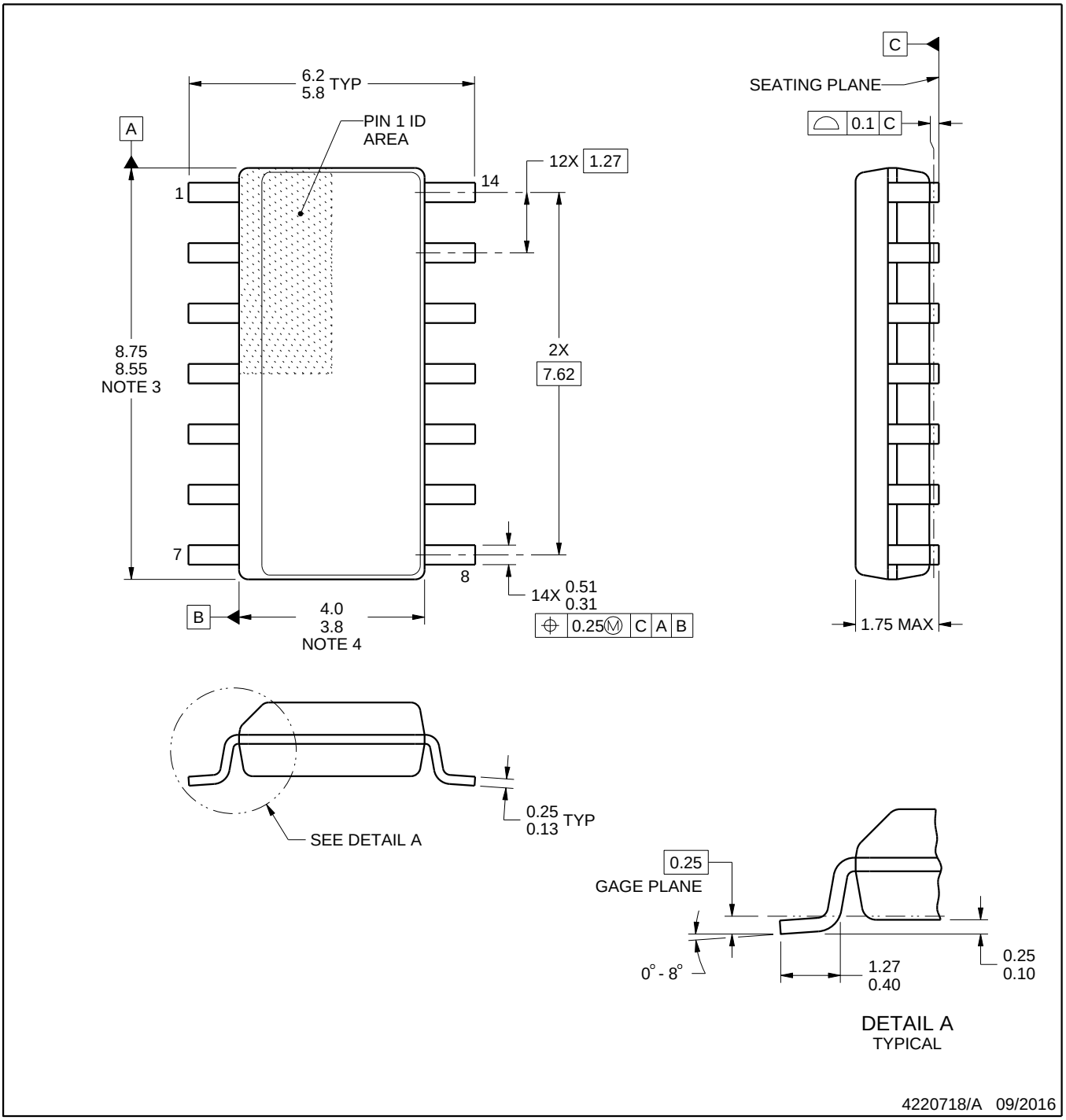


PACKAGE OUTLINE

D0014A

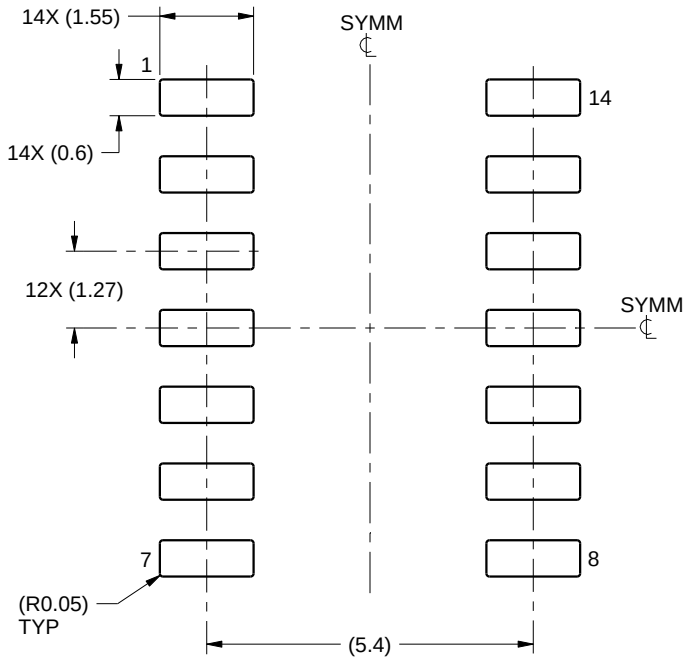
SOIC - 1.75 mm max height

SMALL OUTLINE INTEGRATED CIRCUIT

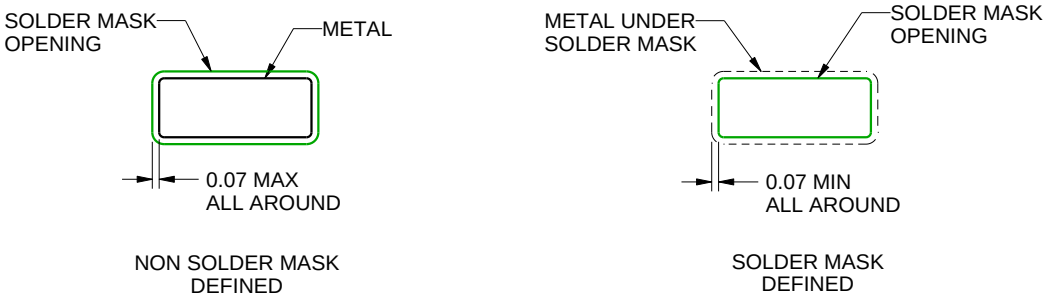


NOTES:

1. All linear dimensions are in millimeters. Dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.15 mm, per side.
4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.43 mm, per side.
5. Reference JEDEC registration MS-012, variation AB.



LAND PATTERN EXAMPLE
SCALE:8X



SOLDER MASK DETAILS

4220718/A 09/2016

NOTES: (continued)

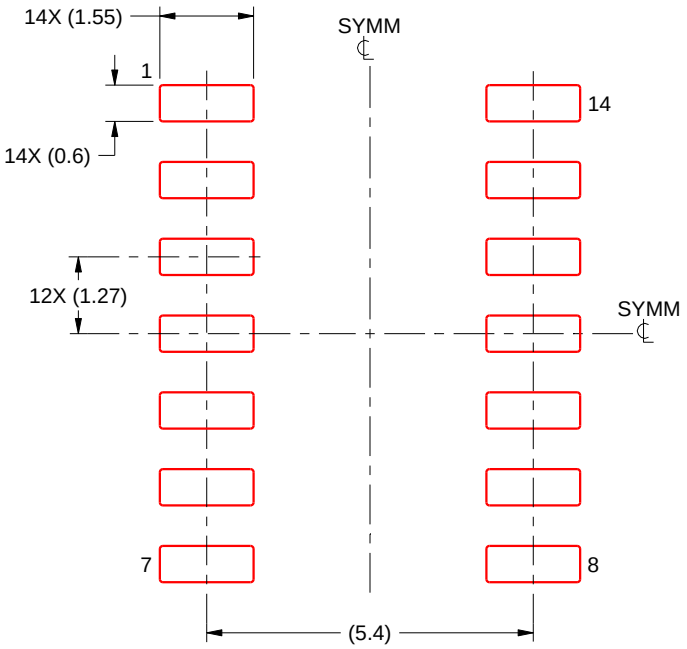
6. Publication IPC-7351 may have alternate designs.
7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

EXAMPLE STENCIL DESIGN

D0014A

SOIC - 1.75 mm max height

SMALL OUTLINE INTEGRATED CIRCUIT



SOLDER PASTE EXAMPLE
BASED ON 0.125 mm THICK STENCIL
SCALE:8X

4220718/A 09/2016

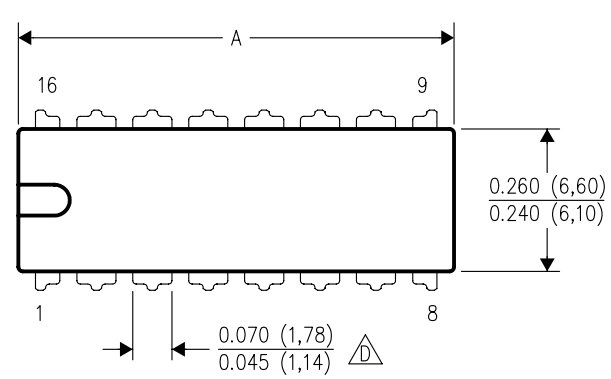
NOTES: (continued)

8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
9. Board assembly site may have different recommendations for stencil design.

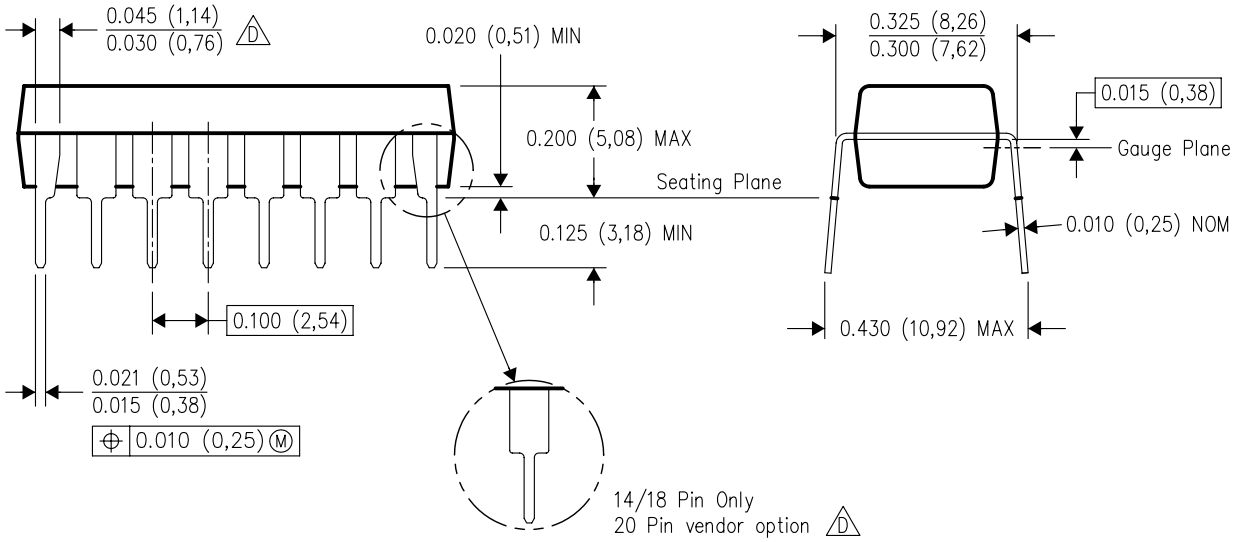
N (R–PDIP–T**)

PLASTIC DUAL–IN–LINE PACKAGE

16 PINS SHOWN



DIM \ PINS **	14	16	18	20
A MAX	0.775 (19,69)	0.775 (19,69)	0.920 (23,37)	1.060 (26,92)
A MIN	0.745 (18,92)	0.745 (18,92)	0.850 (21,59)	0.940 (23,88)
MS–001 VARIATION (C)	AA	BB	AC	AD



4040049/E 12/2002

NOTES:
A. All linear dimensions are in inches (millimeters).
B. This drawing is subject to change without notice.
C. Falls within JEDEC MS–001, except 18 and 20 pin minimum body length (Dim A).
D. The 20 pin end lead shoulder width is a vendor option, either half or full width.

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